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| Form 1449 (Modified) | | Atty Docket No. NSC1P205D2 | Application No.: <u>Not yet assigned</u> |
| Information Disclosure Statement By Applicant | | Applicant: Nguyen et al. | 10/652 805 |
| (Use Several Sheets if Necessary) | | Filing Date August 29, 2003 | Group 2811 <u>Not yet assigned</u> |

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| Examiner Initial | No. | Patent No. | Date | Patentee | Class | Sub-class | Filing Date |
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| Examiner Initial | No. | Document No. | Publication Date | Country or Patent Office | Class | Sub-class | Translation | |
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| Examiner | | Date Considered <i>Kang, Donghee</i> 01-07-04 |

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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| Examiner | Kang, Donghee | Date Considered | 07-07-04 |
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